

# MA3S132A (MA132A), MA3S132K (MA132K)

# Silicon epitaxial planar type

For switching circuits

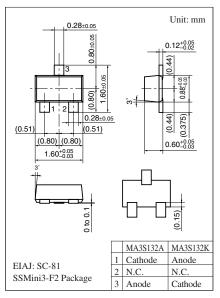
### ■ Features

- Short reverse recovery time t<sub>rr</sub>
- Small terminal capacitance C<sub>t</sub>
- Allowing high-density mounting

# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	80	V
Maximum peak reverse voltage	$V_{RM}$	80	V
Forward current	$I_{F}$	100	mA
Peak forward current	$I_{FM}$	225	mA
Non-repetitive peak forward surge current *	$I_{FSM}$	500	mA
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

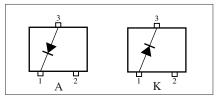
Note) \*: t = 1 s



Marking Symbol:

MA3S132A: MB
 MA3S132K: MI

#### Internal Connection

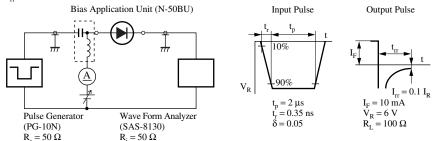


# ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage	V <sub>R</sub>	$I_R = 100 \mu A$	80			V
Reverse current	$I_R$	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	Ct	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$			2	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			3	ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

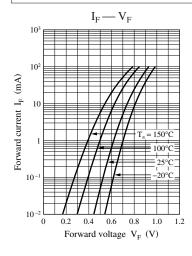
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

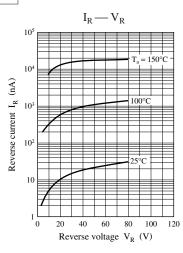
- 2. Absolute frequency of input and output is 100 MHz.
- 3. \*: t<sub>rr</sub> measurement circuit

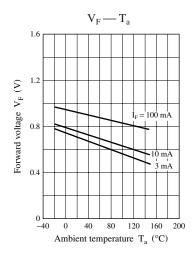


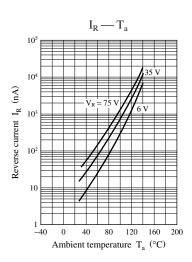
Note) The part numbers in the parenthesis show conventional part number.

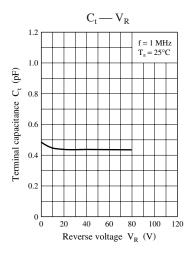
### Characteristics charts of MA3S132A

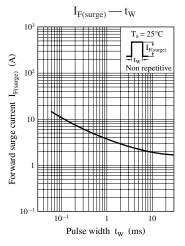




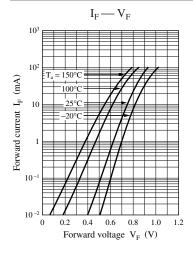


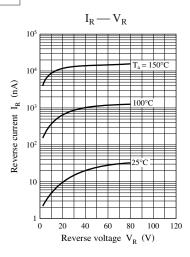


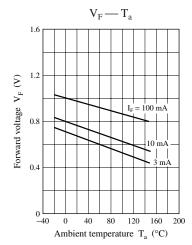


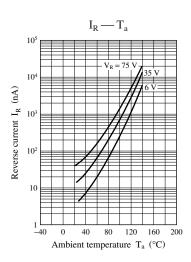


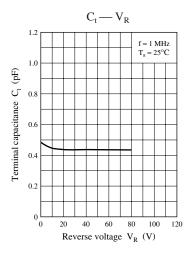
## Characteristics charts of MA3S132K

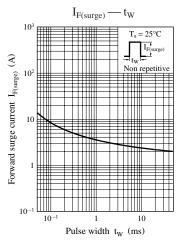












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